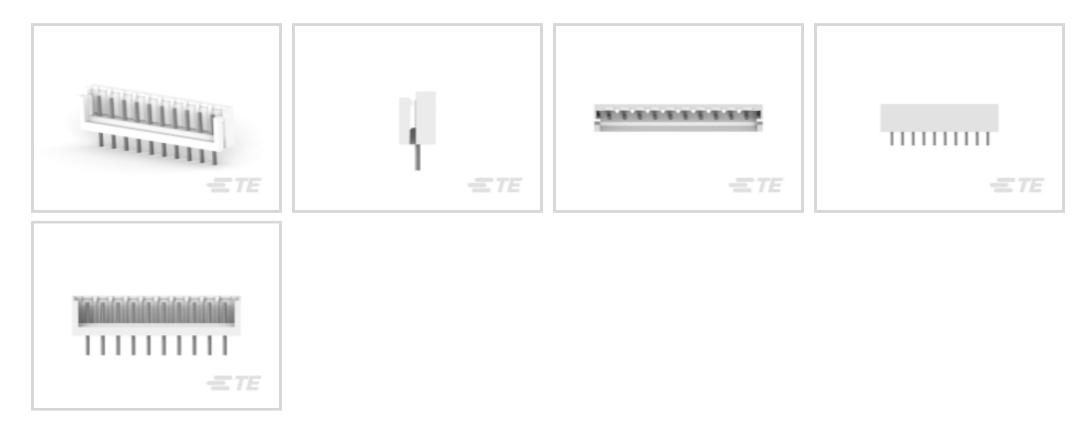
1-177537-0 - ACTIVE

MIS

TE Internal #: 1-177537-0 PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2.5 mm [. 098 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MIS

View on TE.com >





Connector System: Wire-to-Board

Number of Positions: 10

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

Features



Product Type Features

Connector System	Wire-to-Board			
Header Type	Partially Shrouded			
Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
PCB Connector Assembly Type	PCB Mount Header			
Configuration Features				
Number of Positions	10			
Number of Rows	1			
PCB Mount Orientation	Vertical			
Electrical Characteristics				
Operating Voltage	250 VAC			
Body Features				
Primary Product Color	Natural			

PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MIS



Contact Features

Contact Mating Area Length	3.4 mm[.134 in]				
Mating Pin Diameter	.6 mm[.024 in]				
Contact Shape & Form	Rounded				
PCB Contact Termination Area Plating Material	Pre-Tin				
Contact Base Material	Brass				
Contact Mating Area Plating Material	Tin				
Contact Type	Pin				
Contact Current Rating (Max)	4 A				
Termination Features					
Round Termination Post & Tail Diameter	.6 mm[.024 in]				
Termination Post & Tail Length	3.17 mm[.125 in]				
Termination Method to Printed Circuit Board	Through Hole - Solder				
Mechanical Attachment					
Mating Alignment Type	Polarization				
Mating Retention	With				
Panel Mount Feature	Without				
PCB Mount Retention Type	Boardlock				
Mating Retention Type	Polarized Lock				
Connector Mounting Type	Board Mount				
Mating Alignment	With				
PCB Mount Alignment	Without				
PCB Mount Retention	With				
Housing Features					
Housing Material	66 Nylon				
Centerline (Pitch)	2.5 mm[.098 in]				
Dimensions					
Connector Length	27.5 mm[1.083 in]				
Connector Height	6.48 mm[.255 in]				
PCB Thickness (Recommended)	1 – 1.6 mm[.039 – .063 in]				
Usage Conditions					
Operating Temperature Range	-25 – 105 °C[-25 – 221 °F]				

PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MIS



Operation/Application

Circuit Application	Signal			
Industry Standards				
UL Flammability Rating	UL 94V-0			
Packaging Features				
Packaging Quantity	500			
Packaging Type	Loose Piece			

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	 No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC 	
EU REACH Regulation (EC) No. 1907/2006		
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per	

homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MIS





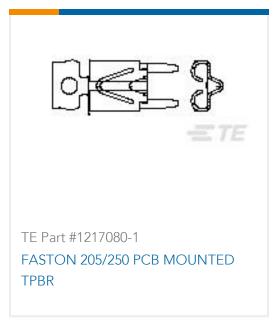
Also in the Series | MIS



Customers Also Bought



TE Part #1717254-4 EMBOSS ASSY DDR2 SODIMM SOCKET 200P 5.2H	TE Part #5-1623732-4 BCHE 7 W 82R 5%	TE Part #8-1625867-2 RP 1J 0.166W 44R2 0.1% 25PPM 1K RL	TE Part #280378-1 4P AMPMODU II SHRD HDR, RT ANG, TIN
ALLALALA A	TE		Left No.1 Pin
TE Part #280377-1 2P AMPMODU II SHRD HDR, RT ANG, TIN	TE Part #1734328-1 Mini USB AB R/A,Rcpt,SMT,TRAY	TE Part #2-2013289-1 EMBOSS TAPE DDR3 204P 5.2H STD	TE Part #9-6447163-9 FSN-11A-10



PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MIS



Documents

Product Drawings 2.5 M.I.S POST HDR ASSY 10P

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_1-177537-0_G.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-177537-0_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-177537-0_G.3d_stp.zip

English

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Product Specifications Application Specification

English

Product Environmental Compliance TE Material Declaration

English

Agency Approvals CSA Certificate

English